





#### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C	
60V	$6\Omega @ V_{GS} = 5V$	200mA	

### **Description**

This MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- Motor Control
- Power Management Functions

## **Features and Benefits**

- N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate, 1.2kV HBM
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

- This part is qualified to JEDEC standards (as references in AEC-Q101) for High Reliability.
- https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

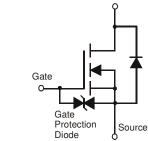
- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (approximate)

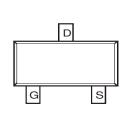
Drain





SOT23





Top View

**Equivalent Circuit** 

Top View Pin-Out

### Ordering Information (Note 4)

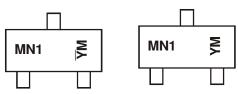
	Part Number	Case	Packaging			
	2N7002A-7	SOT23	3,000/Tape & Reel			
2N7002A-13		SOT23	10,000/Tape & Reel			
Notes:	s: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



## **Marking Information**



Chengdu A/T Site Shanghai A/T Site

MN1 = Product Type Marking Code

 $\underline{YM}$  = Date Code Marking for SAT (Shanghai Assembly/ Test site)  $\underline{\overline{YM}}$  = Date Code Marking for CAT (Chengdu Assembly/ Test site)

Y or  $\overline{Y}$  = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	2008		2009	2010		2011	2012	1	2013	2014		2015
Code	V		W	X		Υ	Z		Α	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		$V_{DSS}$	60	V	
Gate-Source Voltage		$V_{GSS}$	±20	V	
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$ $T_A = +100^{\circ}C$ $T_A = +25^{\circ}C$	I <sub>D</sub>	180 130 115 220	mA
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V Steady State T <sub>A</sub>		$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$ $T_A = +100^{\circ}C$	I <sub>D</sub>	160 140	mA
Maximum Continuous Body Diode Forward Current	(Note 6)	$I_S$	0.5	Α	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)		I <sub>DM</sub>	800	mA	

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Dawar Dissination	(Note 5)	В	370	mW	
Total Power Dissipation	(Note 6)	P <sub>D</sub>	540	IIIVV	
Thermal Resistance, Junction to Ambient	(Note 5)	В	348		
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	241	°C/W	
Thermal Resistance, Junction to Case (Note 6)		R <sub>0</sub> JC	91		
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C	

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout
- 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.

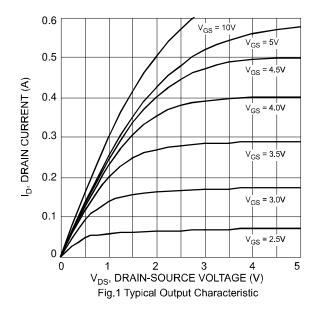


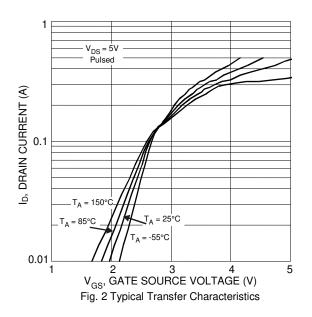
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				•		•	
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	60	70	_	V	$V_{GS} = 0V$ , $I_D = 10\mu A$
Zero Gate Voltage Drain Current	@ T <sub>C</sub> = +25°C @ T <sub>C</sub> = +125°C	I <sub>DSS</sub>	_	_	1.0 500	μΑ	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V
Gate-Body Leakage		I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage		V <sub>GS(th)</sub>	1.2		2.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	@ T <sub>J</sub> = +25°C	R <sub>DS(ON)</sub>	_	3.5	6 5	Ω	$V_{GS} = 5.0V, I_D = 0.115A$
	@ $T_J = +125$ °C			3.0			$V_{GS} = 10V, I_D = 0.115A$
Forward Transconductance		<b>g</b> FS	80		_	mS	V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.115A
DYNAMIC CHARACTERISTICS (Note	8)			•		•	
Input Capacitance		Ciss	_	23	_	pF	
Output Capacitance		Coss	_	3.4	_	pF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance		C <sub>rss</sub>	_	1.4	_	pF	]
Gate Resistance		$R_{G}$	_	260	400	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
SWITCHING CHARACTERISTICS (No	ote 8)				•	•	•
Turn-On Delay Time		t <sub>D(ON)</sub>	_	10	_	ns	$V_{DD} = 30V, I_D = 0.115A, R_L = 150\Omega,$
Turn-Off Delay Time		t <sub>D(OFF)</sub>	_	33	_	ns	$V_{GEN} = 10V$ , $R_{GEN} = 25\Omega$

Notes:

- 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.







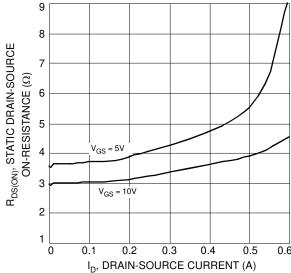


Fig. 3 On-Resistance vs. Drain Current & Gate Voltage

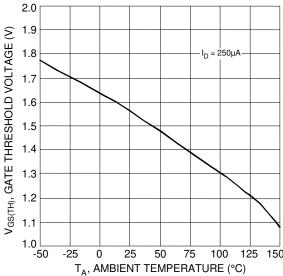


Fig. 5 Gate Threshold Variation vs. Ambient Temperature

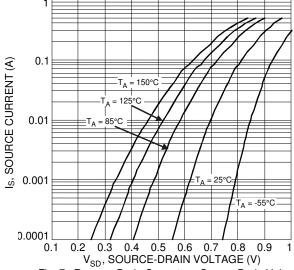


Fig. 7 Reverse Drain Current vs. Source-Drain Voltage

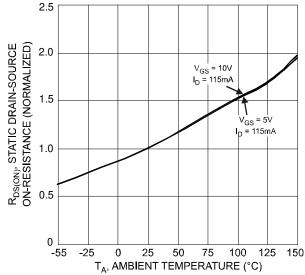
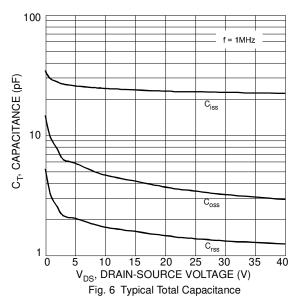


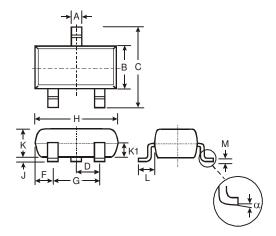
Fig. 4 Normalized Static Drain-Source On-Resistance vs. Ambient Temperature





## **Package Outline Dimensions**

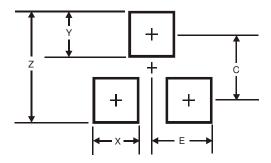
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23								
Dim	Min	Max	Тур						
Α	0.37	0.51	0.40						
В	1.20	1.40	1.30						
С	2.30	2.50	2.40						
D	0.89	1.03	0.915						
F	0.45	0.60	0.535						
G	1.78	2.05	1.83						
H	2.80	3.00	2.90						
7	0.013	0.10	0.05						
K	0.903	1.10	1.00						
K1	-	-	0.400						
L	0.45	0.61	0.55						
М	0.085	0.18	0.11						
α	0°	8°	-						
All	All Dimensions in mm								

# **Suggested Pad Layout**

 $\label{prop:please} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35



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